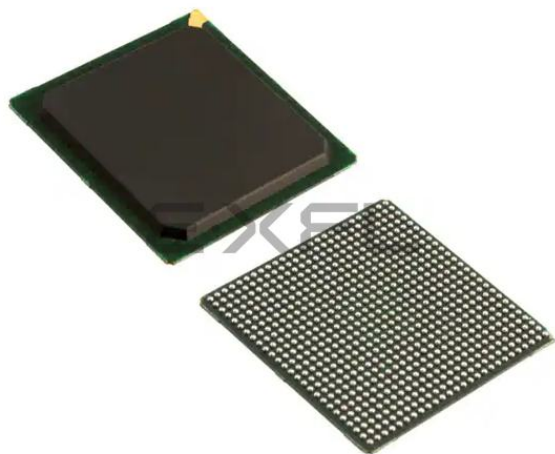




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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	2320
Number of Logic Elements/Cells	20880
Total RAM Bits	1622016
Number of I/O	404
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp20-5fgg676i

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Virtex-II Pro Data Sheet

The Virtex-II Pro Data Sheet contains the following modules:

- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Introduction and Overview (Module 1)
- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Functional Description (Module 2)
- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: DC and Switching Characteristics (Module 3)
- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Pinout Information (Module 4)

Disparity Control

The 8B/10B encoder is initialized with a negative running disparity. Unique control allows forcing the current running disparity state.

TXRUNDISP signals its current running disparity. This may be useful in those cases where there is a need to manipulate the initial running disparity value.

Bits TXCHARDISPMODE and TXCHARDISPVAL control the generation of running disparity before each byte.

For example, the transceiver can generate the sequence

```
K28.5+ K28.5+ K28.5- K28.5-
or
K28.5- K28.5- K28.5+ K28.5+
```

by specifying inverted running disparity for the second and fourth bytes.

Transmit FIFO

Proper operation of the circuit is only possible if the FPGA clock (TXUSRCLK) is frequency-locked to the reference clock (REFCLK). Phase variations up to one clock cycle are allowable. The FIFO has a depth of four. Overflow or underflow conditions are detected and signaled at the interface. Bypassing of this FIFO is programmable.

8B/10B Encoder

Note: In the RocketIO transceiver, the most-significant byte is sent first; in the RocketIO X transceiver, the least-significant byte is sent first.

A bypassable 8B/10B encoder is included. The encoder uses the same 256 data characters and 12 control characters used by Gigabit Ethernet, Fibre Channel, and InfiniBand.

The encoder accepts 8 bits of data along with a K-character signal for a total of 9 bits per character applied, and generates a 10 bit character for transmission. If the K-character signal is High, the data is encoded into one of the twelve possible K-characters available in the 8B/10B code. If the K-character input is Low, the 8 bits are encoded as standard data. If the K-character input is High, and a user applies other than one of the twelve possible combinations, TXKERR indicates the error.

8B/10B Decoder

Note: In the RocketIO transceiver, the most-significant byte is sent first; in the RocketIO X transceiver, the least-significant byte is sent first.

An optional 8B/10B decoder is included. A programmable option allows the decoder to be bypassed. When the 8B/10B decoder is bypassed, the 10-bit character order is, for example,

```
RXCHARISK[0]          (first bit received)
RXRUNDISP[0]
RXDATA[7:0]           (last bit received is RXDATA[0])
```

The decoder uses the same table that is used for Gigabit Ethernet, Fibre Channel, and InfiniBand. In addition to

decoding all data and K-characters, the decoder has several extra features. The decoder separately detects both "disparity errors" and "out-of-band" errors. A disparity error is the reception of 10-bit character that exists within the 8B/10B table but has an incorrect disparity. An out-of-band error is the reception of a 10-bit character that does not exist within the 8B/10B table. It is possible to obtain an out-of-band error without having a disparity error. The proper disparity is always computed for both legal and illegal characters. The current running disparity is available at the RXRUNDISP signal.

The 8B/10B decoder performs a unique operation if out-of-band data is detected. If out-of-band data is detected, the decoder signals the error and passes the illegal 10-bits through and places them on the outputs. This can be used for debugging purposes if desired.

The decoder also signals the reception of one of the 12 valid K-characters. In addition, a programmable comma detect is included. The comma detect signal registers a comma on the receipt of any comma+, comma-, or both. Since the comma is defined as a 7-bit character, this includes several out-of-band characters. Another option allows the decoder to detect only the three defined commas (K28.1, K28.5, and K28.7) as comma+, comma-, or both. In total, there are six possible options, three for valid commas and three for "any comma."

Note that all bytes (1, 2, 4, or 8) at the RX FPGA interface each have their own individual 8B/10B indicators (K-character, disparity error, out-of-band error, current running disparity, and comma detect).

Receiver Buffer

The receiver includes buffers (FIFOs) in the datapath. This section gives the reasons for including the buffers and outlines their operation.

The receiver buffer is required for two reasons:

- *Clock correction* to accommodate the slight difference in frequency between the recovered clock RXRECCLK and the internal FPGA user clock RXUSRCLK
- *Channel bonding* to allow realignment of the input stream to ensure proper alignment of data being read through multiple transceivers

The receiver uses an *elastic buffer*, where "elastic" refers to the ability to modify the read pointer for clock correction and channel bonding.

Comma Detection

Word alignment is dependent on the state of comma detect bits. If comma detect is enabled, the transceiver recognizes up to two 10-bit preprogrammed characters. Upon detection of the character or characters, the comma detect output is driven high and the data is synchronously aligned. If a comma is detected and the data is aligned, no further alignment alteration takes place. If a comma is received and realignment is necessary, the data is realigned and an indi-

Table 27: RocketIO Transmitter Switching Characteristics

Description	Symbol	Conditions	Min	Typ	Max	Units
Serial data rate, full-speed clock	F _{GTX}	Flipchip packages	1.0		3.125 ⁽¹⁾	Gb/s
		Wirebond packages	1.0		2.5 ⁽¹⁾	Gb/s
Serial data rate, half-speed clock ⁽³⁾ (2X oversampling)		Flipchip packages	0.600		1.0	Gb/s
Wirebond packages		0.600		1.0	Gb/s	
Serial data output deterministic jitter	T _{DJ}	2.126 Gb/s – 3.125 Gb/s			0.17	UI ⁽²⁾
		1.0626 Gb/s – 2.125 Gb/s			0.08	UI
		1.0 Gb/s – 1.0625 Gb/s			0.05	UI
		600 Mb/s – 999 Mb/s			0.08 ⁽⁴⁾	UI
Serial data output random jitter	T _{RJ}	2.126 Gb/s – 3.125 Gb/s			0.18	UI
		1.0626 Gb/s – 2.125 Gb/s			0.19	UI
		1.0 Gb/s – 1.0625 Gb/s			0.18	UI
		600 Mb/s – 999 Mb/s			0.18 ⁽⁴⁾	UI
TX rise time	T _{RTX}	20% – 80%		120		ps
TX fall time	T _{FTX}			120		ps
Transmit latency ⁽⁵⁾	T _{TXLAT}	Including CRC		14	17	TXUSR CLK cycles
		Excluding CRC		8	11	
TXUSRCLK duty cycle	T _{TXDC}		45	50	55	%
TXUSRCLK2 duty cycle	T _{TX2DC}		45	50	55	%

Notes:

1. Serial data rate in the -5 speed grade is limited to 2.0 Gb/s in both wirebond and flipchip packages.
2. UI = Unit Interval
3. For serial rates under 1 Gb/s, the 3X (or greater) oversampling techniques described in [XAPP572](#) are required to meet the transmit jitter and receive jitter tolerance specifications defined in this data sheet.
4. The oversampling techniques described in [XAPP572](#) are required to meet these specifications for serial rates less than 1 Gb/s.
5. Transmit latency delay TXDATA to TXP/TXN. Refer to [RocketIO Transceiver User Guide](#) for more information on calculating latency.

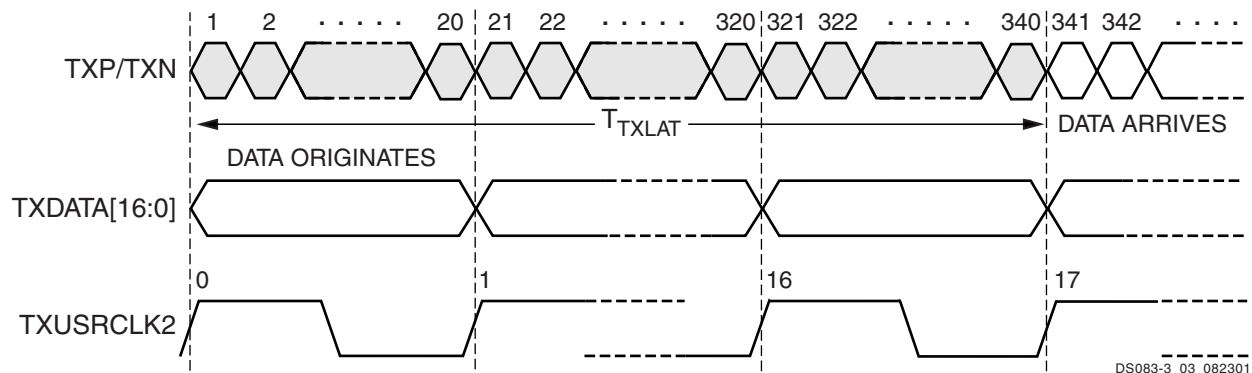


Figure 5: RocketIO Transmit Latency (Maximum, Including CRC)

Virtex-II Pro Pin-to-Pin Input Parameter Guidelines

All devices are 100% functionally tested. Listed below are representative values for typical pin locations and normal clock loading. Values are expressed in nanoseconds unless otherwise noted

Global Clock Set-Up and Hold for LVCMOS25 Standard, *With DCM*

Table 55: Global Clock Set-Up and Hold for LVCMOS25 Standard, With DCM

			Speed Grade			
Description	Symbol	Device	-7	-6	-5	Units
Input Setup and Hold Time Relative to Global Clock Input Signal for LVCMOS25 Standard. ⁽¹⁾ For data input with different standards, adjust the setup time delay by the values shown in IOB Input Switching Characteristics Standard Adjustments, page 25 .						
No Delay Global Clock and IFF ⁽²⁾ with DCM	T _{PSDCM} /T _{PHDCM}	XC2VP2	1.54/–0.58	1.54/–0.57	1.54/–0.56	ns
		XC2VP4	1.59/–0.59	1.59/–0.58	1.59/–0.57	ns
		XC2VP7	1.66/–0.61	1.66/–0.59	1.66/–0.57	ns
		XC2VP20	1.68/–0.53	1.68/–0.53	1.68/–0.50	ns
		XC2VPX20	1.68/–0.53	1.68/–0.53	1.68/–0.50	ns
		XC2VP30	1.81/–0.74	1.81/–0.74	1.81/–0.71	ns
		XC2VP40	1.85/–0.65	1.85/–0.64	1.85/–0.60	ns
		XC2VP50	1.85/–0.57	1.85/–0.54	1.85/–0.50	ns
		XC2VP70	1.86/–0.45	1.86/–0.39	1.86/–0.30	ns
		XC2VPX70	1.86/–0.45	1.86/–0.39	1.86/–0.30	ns
		XC2VP100	N/A	1.86/–0.35	1.87/–0.28	ns

Notes:

- Setup time is measured relative to the Global Clock input signal with the fastest route and the lightest load. Hold time is measured relative to the Global Clock input signal with the slowest route and heaviest load.
- These measurements include:
 - CLK0 and CLK180 DCM jitter
 - Worst-case duty-cycle distortion using CLK0 and CLK180, T_{DCD_CLK180} .
- IFF = Input Flip-Flop or Latch

Global Clock Set-Up and Hold for LVCMOS25 Standard, *Without DCM*

Table 56: Global Clock Set-Up and Hold for LVCMOS25 Standard, *Without DCM*

			Speed Grade			
Description	Symbol	Device	-7	-6	-5	Units
Input Setup and Hold Time Relative to Global Clock Input Signal for LVCMOS25 Standard. For data input with different standards, adjust the setup time delay by the values shown in IOB Input Switching Characteristics Standard Adjustments , page 25.						
Full Delay Global Clock and IFF without DCM	T_{PSFD}/T_{PHFD}	XC2VP2	1.80/–0.44	1.85/–0.41	1.96/–0.43	ns
		XC2VP4	1.82/–0.53	1.83/–0.31	1.90/–0.29	ns
		XC2VP7	1.80/–0.34	1.81/–0.24	1.88/–0.19	ns
		XC2VP20	1.76/–0.24	1.83/–0.17	1.92/–0.15	ns
		XC2VPX20	1.76/–0.24	1.83/–0.17	1.92/–0.15	ns
		XC2VP30	1.75/–0.22	1.92/–0.26	1.99/–0.23	ns
		XC2VP40	2.25/–0.54	2.40/–0.56	2.49/–0.54	ns
		XC2VP50	2.93/–1.02	2.98/–0.93	3.00/–0.83	ns
		XC2VP70	2.79/–0.72	2.79/–0.55	2.78/–0.41	ns
		XC2VPX70	2.79/–0.72	2.79/–0.55	2.78/–0.41	ns
		XC2VP100	N/A	5.58/–2.35	5.60/–2.35	ns

Notes:

1. IFF = Input Flip-Flop or Latch
2. Setup time is measured relative to the Global Clock input signal with the fastest route and the lightest load. Hold time is measured relative to the Global Clock input signal with the slowest route and heaviest load.
3. A Zero “0” Hold Time listing indicates no hold time or a negative hold time. Negative values can not be guaranteed “best-case”, but if a “0” is listed, there is no positive hold time.

Table 8: FF672 — XC2VP2, XC2VP4, and XC2VP7

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
3	IO_L90N_3	P2			
3	IO_L90P_3	P3			
3	IO_L89N_3	P4			
3	IO_L89P_3	P5			
3	IO_L88N_3	P6			
3	IO_L88P_3	P7			
3	IO_L87N_3/VREF_3	R1			
3	IO_L87P_3	R2			
3	IO_L86N_3	R3			
3	IO_L86P_3	R4			
3	IO_L85N_3	R5			
3	IO_L85P_3	R6			
3	IO_L60N_3	P8	NC		
3	IO_L60P_3	R8	NC		
3	IO_L59N_3	T1	NC		
3	IO_L59P_3	T2	NC		
3	IO_L58N_3	T3	NC		
3	IO_L58P_3	T4	NC		
3	IO_L57N_3/VREF_3	T5	NC		
3	IO_L57P_3	T6	NC		
3	IO_L56N_3	R7	NC		
3	IO_L56P_3	T7	NC		
3	IO_L55N_3	T8	NC		
3	IO_L55P_3	U7	NC		
3	IO_L54N_3	U1	NC		
3	IO_L54P_3	V1	NC		
3	IO_L53N_3	U3	NC		
3	IO_L53P_3	U4	NC		
3	IO_L52N_3	U5	NC		
3	IO_L52P_3	U6	NC		
3	IO_L51N_3/VREF_3	V2	NC		
3	IO_L51P_3	V3	NC		
3	IO_L50N_3	V4	NC		
3	IO_L50P_3	V5	NC		
3	IO_L49N_3	V6	NC		
3	IO_L49P_3	V7	NC		

Table 8: FF672 — XC2VP2, XC2VP4, and XC2VP7

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
6	IO_L01P_6/VRN_6	AF24			
6	IO_L01N_6/VRP_6	AE24			
6	IO_L02P_6	AD23			
6	IO_L02N_6	AC24			
6	IO_L03P_6	AE26			
6	IO_L03N_6/VREF_6	AF25			
6	IO_L04P_6	AD25			
6	IO_L04N_6	AD26			
6	IO_L05P_6	AC25			
6	IO_L05N_6	AC26			
6	IO_L06P_6	AB23			
6	IO_L06N_6	AB24			
6	IO_L39P_6	AB25	NC	NC	NC
6	IO_L39N_6/VREF_6	AB26	NC	NC	NC
6	IO_L41P_6	AA22	NC	NC	NC
6	IO_L41N_6	AA23	NC	NC	NC
6	IO_L42P_6	AA24	NC	NC	NC
6	IO_L42N_6	AA25	NC	NC	NC
6	IO_L43P_6	Y21	NC		
6	IO_L43N_6	Y22	NC		
6	IO_L44P_6	Y23	NC		
6	IO_L44N_6	Y24	NC		
6	IO_L45P_6	AA26	NC		
6	IO_L45N_6/VREF_6	Y26	NC		
6	IO_L46P_6	W21	NC		
6	IO_L46N_6	W22	NC		
6	IO_L47P_6	W23	NC		
6	IO_L47N_6	W24	NC		
6	IO_L48P_6	W25	NC		
6	IO_L48N_6	W26	NC		
6	IO_L49P_6	V20	NC		
6	IO_L49N_6	V21	NC		
6	IO_L50P_6	V22	NC		
6	IO_L50N_6	V23	NC		
6	IO_L51P_6	V24	NC		
6	IO_L51N_6/VREF_6	V25	NC		
6	IO_L52P_6	U21	NC		

Table 10: FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
4	IO_L27P_4/VREF_4	AL10	NC	NC		
4	IO_L37N_4	AE13				
4	IO_L37P_4	AF13				
4	IO_L38N_4	AG13				
4	IO_L38P_4	AH13				
4	IO_L39N_4	AJ11				
4	IO_L39P_4	AK11				
4	IO_L43N_4	AE14				
4	IO_L43P_4	AF14				
4	IO_L44N_4	AJ13				
4	IO_L44P_4	AK13				
4	IO_L45N_4	AL11				
4	IO_L45P_4/VREF_4	AM11				
4	IO_L46N_4	AE15				
4	IO_L46P_4	AF15				
4	IO_L47N_4	AG14				
4	IO_L47P_4	AH14				
4	IO_L48N_4	AL13				
4	IO_L48P_4	AL12				
4	IO_L49N_4	AD16				
4	IO_L49P_4	AE16				
4	IO_L50_4/No_Pair	AJ14				
4	IO_L53_4/No_Pair	AK14				
4	IO_L54N_4	AM14				
4	IO_L54P_4	AM13				
4	IO_L55N_4	AF16				
4	IO_L55P_4	AG16				
4	IO_L56N_4	AH15				
4	IO_L56P_4	AJ15				
4	IO_L57N_4	AL14				
4	IO_L57P_4/VREF_4	AL15				
4	IO_L67N_4	AD17				
4	IO_L67P_4	AE17				
4	IO_L68N_4	AH16				
4	IO_L68P_4	AJ16				
4	IO_L69N_4	AK16				
4	IO_L69P_4/VREF_4	AL16				
4	IO_L73N_4	AF17				

Table 10: FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
N/A	VCCINT	Y13				
N/A	VCCINT	Y22				
N/A	VCCINT	AA13				
N/A	VCCINT	AA22				
N/A	VCCINT	AB13				
N/A	VCCINT	AB14				
N/A	VCCINT	AB15				
N/A	VCCINT	AB16				
N/A	VCCINT	AB17				
N/A	VCCINT	AB18				
N/A	VCCINT	AB19				
N/A	VCCINT	AB20				
N/A	VCCINT	AB21				
N/A	VCCINT	AB22				
N/A	VCCINT	AC12				
N/A	VCCINT	AC23				
N/A	VCCINT	AD11				
N/A	VCCINT	AD24				
N/A	VCCAUX	C3				
N/A	VCCAUX	C4				
N/A	VCCAUX	C17				
N/A	VCCAUX	C18				
N/A	VCCAUX	C31				
N/A	VCCAUX	C32				
N/A	VCCAUX	D3				
N/A	VCCAUX	D32				
N/A	VCCAUX	U1				
N/A	VCCAUX	V1				
N/A	VCCAUX	U34				
N/A	VCCAUX	V34				
N/A	VCCAUX	AL3				
N/A	VCCAUX	AL32				
N/A	VCCAUX	AM3				
N/A	VCCAUX	AM4				
N/A	VCCAUX	AM17				
N/A	VCCAUX	AM18				
N/A	VCCAUX	AM31				
N/A	VCCAUX	AM32				

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
N/A	VCCINT	M12		
N/A	VCCINT	AD11		
N/A	VCCINT	L11		
N/A	VCCAUX	AN34		
N/A	VCCAUX	AG34		
N/A	VCCAUX	U34		
N/A	VCCAUX	H34		
N/A	VCCAUX	B34		
N/A	VCCAUX	AP33		
N/A	VCCAUX	A33		
N/A	VCCAUX	AP27		
N/A	VCCAUX	A27		
N/A	VCCAUX	AP17		
N/A	VCCAUX	A17		
N/A	VCCAUX	AP8		
N/A	VCCAUX	A8		
N/A	VCCAUX	AP2		
N/A	VCCAUX	A2		
N/A	VCCAUX	AN1		
N/A	VCCAUX	AG1		
N/A	VCCAUX	U1		
N/A	VCCAUX	H1		
N/A	VCCAUX	B1		
N/A	GND	AK34		
N/A	GND	AF34		
N/A	GND	AB34		
N/A	GND	W34		
N/A	GND	V34		
N/A	GND	T34		
N/A	GND	N34		
N/A	GND	J34		
N/A	GND	E34		
N/A	GND	AN33		
N/A	GND	B33		
N/A	GND	AM32		
N/A	GND	C32		
N/A	GND	AP30		
N/A	GND	AK30		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
3	IO_L90P_3	AA8		
3	IO_L89N_3	Y11		
3	IO_L89P_3	Y12		
3	IO_L88N_3	AA5		
3	IO_L88P_3	AA6		
3	IO_L87N_3/VREF_3	AA3		
3	IO_L87P_3	AA4		
3	IO_L86N_3	Y13		
3	IO_L86P_3	AA13		
3	IO_L85N_3	AB7		
3	IO_L85P_3	AB8		
3	IO_L60N_3	AB5		
3	IO_L60P_3	AB6		
3	IO_L59N_3	AA9		
3	IO_L59P_3	AA10		
3	IO_L58N_3	AB3		
3	IO_L58P_3	AB4		
3	IO_L57N_3/VREF_3	AB1		
3	IO_L57P_3	AB2		
3	IO_L56N_3	AA11		
3	IO_L56P_3	AA12		
3	IO_L55N_3	AC5		
3	IO_L55P_3	AC6		
3	IO_L54N_3	AC1		
3	IO_L54P_3	AC2		
3	IO_L53N_3	AB9		
3	IO_L53P_3	AB10		
3	IO_L52N_3	AC8		
3	IO_L52P_3	AD8		
3	IO_L51N_3/VREF_3	AC4		
3	IO_L51P_3	AD4		
3	IO_L50N_3	AB11		
3	IO_L50P_3	AB12		
3	IO_L49N_3	AD6		
3	IO_L49P_3	AD7		
3	IO_L48N_3	AD2		
3	IO_L48P_3	AD3		
3	IO_L47N_3	AC9		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
7	IO_L43N_7	R37		
7	IO_L42P_7	R34		
7	IO_L42N_7	R35		
7	IO_L41P_7	U28		
7	IO_L41N_7	T28		
7	IO_L40P_7	R32		
7	IO_L40N_7/VREF_7	R33		
7	IO_L39P_7	P38		
7	IO_L39N_7	P39		
7	IO_L38P_7	T29		
7	IO_L38N_7	T30		
7	IO_L37P_7	N37		
7	IO_L37N_7	P37		
7	IO_L36P_7	P35		
7	IO_L36N_7	P36		
7	IO_L35P_7	T27		
7	IO_L35N_7	R27		
7	IO_L34P_7	P33		
7	IO_L34N_7/VREF_7	P34		
7	IO_L33P_7	N38		
7	IO_L33N_7	N39		
7	IO_L32P_7	R28		
7	IO_L32N_7	R29		
7	IO_L31P_7	N35		
7	IO_L31N_7	M36		
7	IO_L30P_7	N33		
7	IO_L30N_7	N34		
7	IO_L29P_7	R30		
7	IO_L29N_7	R31		
7	IO_L28P_7	M37		
7	IO_L28N_7/VREF_7	M38		
7	IO_L27P_7	M33		
7	IO_L27N_7	M34		
7	IO_L26P_7	P28		
7	IO_L26N_7	P29		
7	IO_L25P_7	L38		
7	IO_L25N_7	L39		
7	IO_L24P_7	L36		

FF1517 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch)

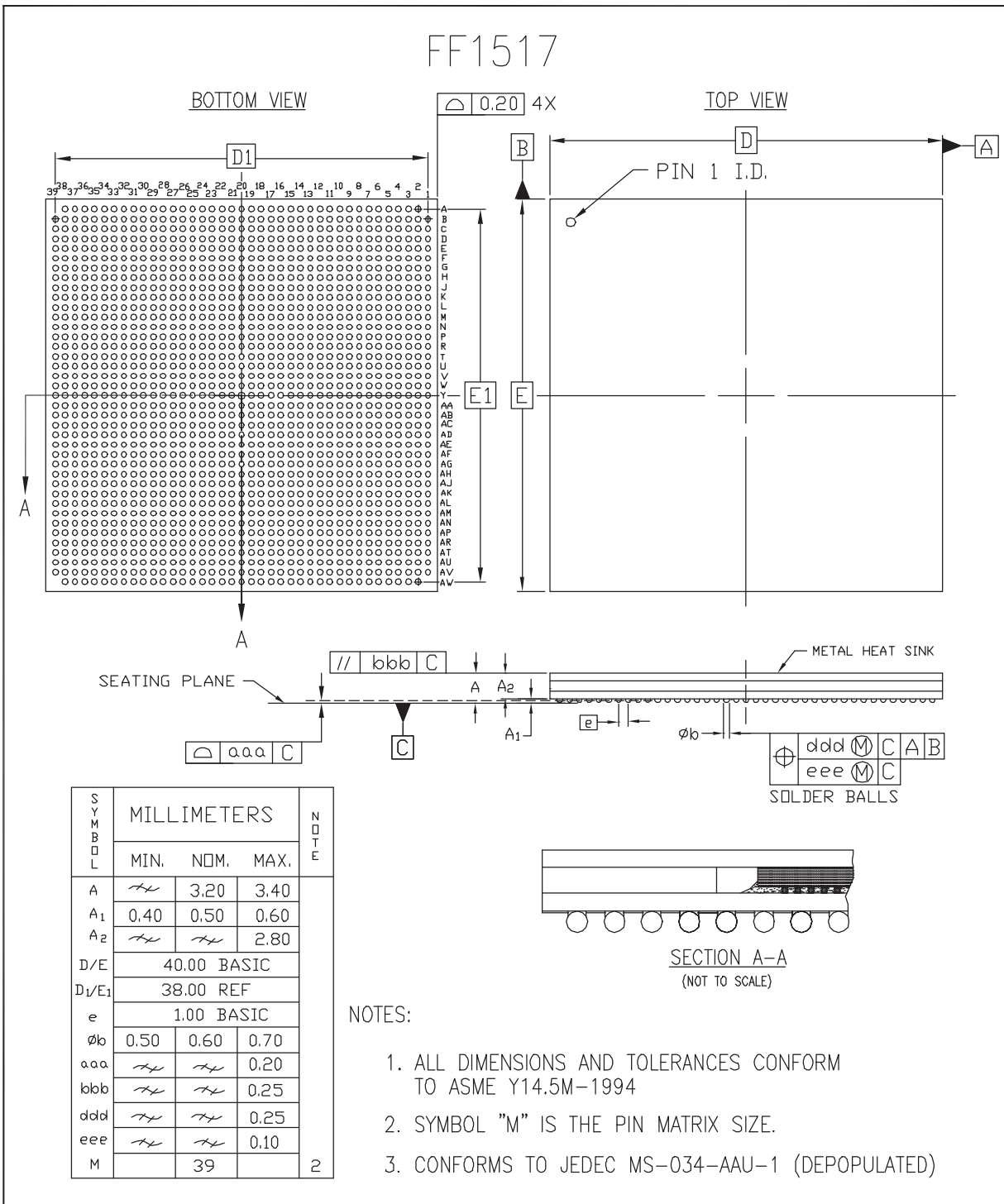


Figure 8: FF1517 Flip-Chip Fine-Pitch BGA Package Specifications

FF1704 Flip-Chip Fine-Pitch BGA Package

As shown in [Table 13](#), XC2VP70 and XC2VP100 Virtex-II Pro devices are available in the FF1704 flip-chip fine-pitch BGA package. Following this table are the [FF1704 Flip-Chip Fine-Pitch BGA Package Specifications \(1.00mm pitch\)](#).

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
0	IO_L01N_0/VRP_0		G34		
0	IO_L01P_0/VRN_0		H34		
0	IO_L02N_0		F34		
0	IO_L02P_0		E34		
0	IO_L03N_0		C34		
0	IO_L03P_0/VREF_0		D34		
0	IO_L05_0/No_Pair		K32		
0	IO_L06N_0		H33		
0	IO_L06P_0		J33		
0	IO_L07N_0		F33		
0	IO_L07P_0		G33		
0	IO_L08N_0		E33		
0	IO_L08P_0		D33		
0	IO_L09N_0		H32		
0	IO_L09P_0/VREF_0		J32		
0	IO_L19N_0		E32		
0	IO_L19P_0		F32		
0	IO_L20N_0		C33		
0	IO_L20P_0		C32		
0	IO_L21N_0		K31		
0	IO_L21P_0		L31		
0	IO_L25N_0		H31		
0	IO_L25P_0		J31		
0	IO_L26N_0		G31		
0	IO_L26P_0		F31		
0	IO_L27N_0		D31		
0	IO_L27P_0/VREF_0		E31		
0	IO_L28N_0		L30		
0	IO_L28P_0		M30		
0	IO_L29N_0		J30		
0	IO_L29P_0		K30		
0	IO_L30N_0		G30		
0	IO_L30P_0		H30		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
5	IO_L19P_5		AV32		
5	IO_L09N_5/VREF_5		AP32		
5	IO_L09P_5		AR32		
5	IO_L08N_5		AW33		
5	IO_L08P_5		AV33		
5	IO_L07N_5/VREF_5		AT33		
5	IO_L07P_5		AU33		
5	IO_L06N_5/VRP_5		AP33		
5	IO_L06P_5/VRN_5		AR33		
5	IO_L05_5/No_Pair		AN32		
5	IO_L03N_5/D4		AW34		
5	IO_L03P_5/D5		AY34		
5	IO_L02N_5/D6		AV34		
5	IO_L02P_5/D7		AU34		
5	IO_L01N_5/RDWR_B		AR34		
5	IO_L01P_5/CS_B		AT34		
6	IO_L01P_6/VRN_6		AW37		
6	IO_L01N_6/VRP_6		AV37		
6	IO_L02P_6		AW36		
6	IO_L02N_6		AV36		
6	IO_L03P_6		AY37		
6	IO_L03N_6/VREF_6		AY38		
6	IO_L04P_6		AU36		
6	IO_L04N_6		AT37		
6	IO_L05P_6		AU35		
6	IO_L05N_6		AT35		
6	IO_L06P_6		AW41		
6	IO_L06N_6		AW42		
6	IO_L73P_6		AV41		
6	IO_L73N_6		AV42		
6	IO_L74P_6		AW40		
6	IO_L74N_6		AV40		
6	IO_L75P_6		AU39		
6	IO_L75N_6/VREF_6		AU40		
6	IO_L76P_6		AU41		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
7	IO_L03P_7		D37		
7	IO_L03N_7		E37		
7	IO_L02P_7		D36		
7	IO_L02N_7		E36		
7	IO_L01P_7/VRN_7		C37		
7	IO_L01N_7/VRP_7		C38		
0	VCCO_0		D25		
0	VCCO_0		G23		
0	VCCO_0		G28		
0	VCCO_0		G32		
0	VCCO_0		J25		
0	VCCO_0		J29		
0	VCCO_0		P22		
0	VCCO_0		P23		
0	VCCO_0		P24		
0	VCCO_0		P25		
0	VCCO_0		P26		
0	VCCO_0		R22		
0	VCCO_0		R23		
0	VCCO_0		R24		
0	VCCO_0		R25		
1	VCCO_1		R21		
1	VCCO_1		R20		
1	VCCO_1		R19		
1	VCCO_1		R18		
1	VCCO_1		P21		
1	VCCO_1		P20		
1	VCCO_1		P19		
1	VCCO_1		P18		
1	VCCO_1		P17		
1	VCCO_1		J18		
1	VCCO_1		J14		
1	VCCO_1		G20		
1	VCCO_1		G15		
1	VCCO_1		G11		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	GND		AU25		
N/A	GND		AU18		
N/A	GND		AU6		
N/A	GND		AV38		
N/A	GND		AV22		
N/A	GND		AV21		
N/A	GND		AV5		
N/A	GND		AW39		
N/A	GND		AW32		
N/A	GND		AW28		
N/A	GND		AW15		
N/A	GND		AW11		
N/A	GND		AW4		
N/A	GND		AY42		
N/A	GND		AY41		
N/A	GND		AY40		
N/A	GND		AY3		
N/A	GND		AY2		
N/A	GND		AY1		
N/A	GND		BA42		
N/A	GND		BA1		
N/A	GND		AA38		
N/A	GND		AA35		
N/A	GND		AA32		
N/A	GND		AA26		
N/A	GND		AA25		
N/A	GND		AA24		
N/A	GND		AA23		
N/A	GND		AA22		
N/A	GND		AA21		
N/A	GND		AA20		
N/A	GND		AA19		
N/A	GND		AA18		
N/A	GND		AA17		
N/A	GND		AA11		
N/A	GND		AA8		

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
5	IO_L10N_5	AW27	NC
5	IO_L10P_5	AW26	NC
5	IO_L45N_5/VREF_5	AN27	
5	IO_L45P_5	AP27	
5	IO_L44N_5	AU27	
5	IO_L44P_5	AV27	
5	IO_L43N_5	AR27	
5	IO_L43P_5	AR26	
5	IO_L39N_5	AL27	
5	IO_L39P_5	AM27	
5	IO_L38N_5	BA28	
5	IO_L38P_5	BB28	
5	IO_L37N_5	AY28	
5	IO_L37P_5	AY27	
5	IO_L87N_5/VREF_5	AN28	
5	IO_L87P_5	AP28	
5	IO_L86N_5	AU28	
5	IO_L86P_5	AV28	
5	IO_L85N_5	AT28	
5	IO_L85P_5	AT27	
5	IO_L84N_5	AL28	
5	IO_L84P_5	AM28	
5	IO_L83_5/No_Pair	BA29	
5	IO_L80_5/No_Pair	BB29	
5	IO_L79N_5	AY29	
5	IO_L79P_5	AW28	
5	IO_L78N_5	AN29	
5	IO_L78P_5	AP29	
5	IO_L77N_5	AU29	
5	IO_L77P_5	AV29	
5	IO_L76N_5	AT29	
5	IO_L76P_5	AR28	
5	IO_L36N_5/VREF_5	AL29	
5	IO_L36P_5	AM29	
5	IO_L35N_5	AY30	
5	IO_L35P_5	BA30	
5	IO_L34N_5	AT30	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
5	VCCO_5	AL30	
5	VCCO_5	AW29	
5	VCCO_5	AR29	
5	VCCO_5	AJ26	
5	VCCO_5	AW25	
5	VCCO_5	AR25	
5	VCCO_5	AJ25	
5	VCCO_5	AH25	
5	VCCO_5	AJ24	
5	VCCO_5	AH24	
5	VCCO_5	AJ23	
5	VCCO_5	AH23	
5	VCCO_5	AJ22	
5	VCCO_5	AH22	
4	VCCO_4	AJ21	
4	VCCO_4	AH21	
4	VCCO_4	AJ20	
4	VCCO_4	AH20	
4	VCCO_4	AJ19	
4	VCCO_4	AH19	
4	VCCO_4	AW18	
4	VCCO_4	AR18	
4	VCCO_4	AJ18	
4	VCCO_4	AH18	
4	VCCO_4	AJ17	
4	VCCO_4	AW14	
4	VCCO_4	AR14	
4	VCCO_4	AL13	
4	VCCO_4	AW10	
3	VCCO_3	AG15	
3	VCCO_3	AF15	
3	VCCO_3	AE15	
3	VCCO_3	AD15	
3	VCCO_3	AC15	
3	VCCO_3	AB15	
3	VCCO_3	AH14	
3	VCCO_3	AG14	

FF1696 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch)

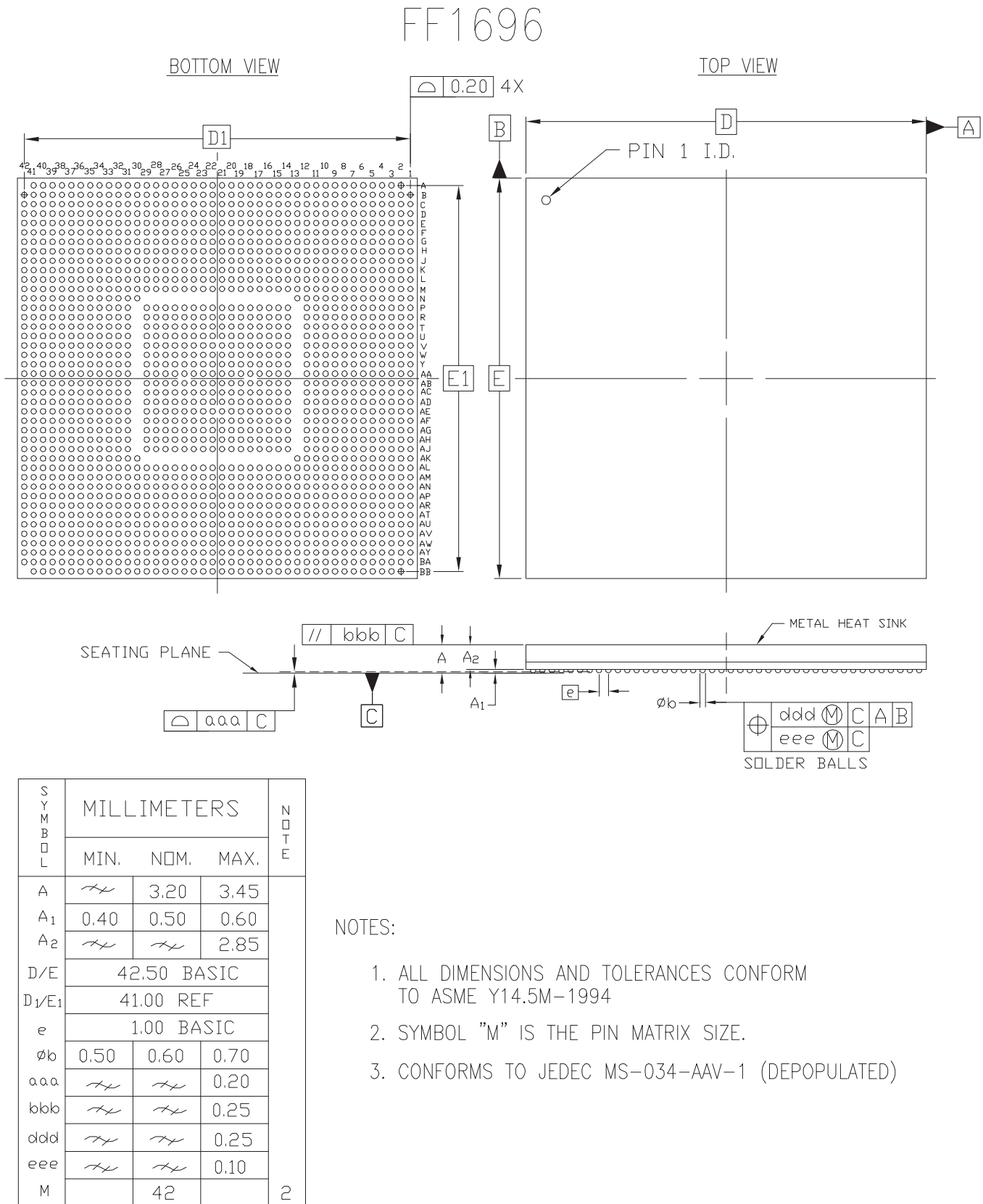


Figure 10: FF1696 Flip-Chip Fine-Pitch BGA Package Specifications